| SF | PFC | IFI | CAT | TIO | NS. |
|----|-----|-----|-----|-----|-----|
| JI | | | UAI | 10 | 110 |

CUSTOMER . CTW1382

SAMPLE CODE . SE9665WRF-002-I02Q

MASS PRODUCTION CODE . PE9665WRF-002-I02Q

SAMPLE VERSION . 02

SPECIFICATIONS EDITION . 005

DRAWING NO. (Ver.) . LMD- PE9665WRF-002-I02Q (Ver:005)

PACKAGING NO. (Ver.) PKG- PE9665WRF-002-I02Q (Ver:003)

Customer Approved

Date:

POWERTIP 2012.12.26 JS RD APPROVED

| Approved | Checked | Designer |
|----------|---------|----------|
| 閆偉 | 劉進 | 趙冬冬 |

Preliminary specification for design input

■ Specification for sample approval

POWERTIP TECH. CORP.

Headquarters:

No.8, 6th Road, Taichung Industrial Park,

Taichung, Taiwan

台中市 407 工業區六路 8號

TEL: 886-4-2355-8168

FAX: 886-4-2355-8166

E-mail: sales@powertip.com.tw

Http://www.powertip.com.tw



History of Version

| Date (mm / dd / yyyy) | Ver. | Edi. | Description | Page | Design by |
|-----------------------|------|------|---|-----------------------|-----------|
| 01/30/2008 | 01 | 001 | New drawing. | - | Louis |
| 02/01/2008 | 01 | 002 | Modify Controller IC to ST7579-G2. Modify 1.1 Features. Modify 1.3 DC Electrical Characteristics. Modify 2.1.2 Block Diagram Modify 2.2 Interface Pin Description | - 3 6 7 8 | Louis |
| 03/28/2008 | 01 | 003 | First Sample Delete color filter | - Appendix | Louis |
| 05/09/2008 | 02 | 004 | Modify B/L. Modify 1.5 Optical Characteristics. Modify 1.6 Backlight Characteristics. | - 6 12 | Louis |
| 12/11/2012 | 02 | 005 | Modify LCM Average Brightness Modify Backlight Average Brightness | 6.12 | 趙冬冬 |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | X | | | |
| | | | | | |
| | | | | | |
| | | | | | |

Total : 26 Page



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix:

- 1. LCM drawing
- 2. LCM Packaging Specifications

Note: For detailed information please refer to IC data sheet: SITRONIX -ST7579-G2



1. SPECIFICATIONS

1.1 Features

| Item | Standard Value |
|-------------------|--|
| Display Type | 96 * 65 Dots |
| LCD Type | FSTN, Positive, Transflective |
| Driver Condition | LCD Module :1/68 Duty, 1/9 Bias |
| Viewing Direction | 6 O'clock |
| Backlight | LED B/L |
| Weight | 5 g |
| Interface | 3-line SPI (serial peripheral interface) |
| Driver IC | SITRONIX – ST7579-G2 |
| | THIS PRODUCT CONFORMS THE ROHS OF PTC |
| ROHS | Detail information please refer web side : |
| | http://www.powertip.com.tw/news/LatestNews.asp |

1.2 Mechanical Specifications

| Item | Standard Value | |
|-------------------|-------------------------------|----|
| Outline Dimension | 34.0 (W) * 30.4 (L) * 3.1 (H) | |
| Viewing Area | 27.8 (W) * 18.9 (L) | mm |
| Active Area | 25.42 (W) * 16.88 (L) | mm |
| Dot Size | 0.245 (W) * 0.24 (H) | mm |
| Dot Pitch | 0.265 (W) * 0.26 (H) | mm |

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

| Item | Symbol | Condition | Min. | Max. | Unit |
|---------------------------|----------|-----------|------|------|------|
| Power Supply Voltage | V_{DD} | _ | -0.3 | 3.6 | V |
| LCD Driver Supply Voltage | V0–XV0 | _ | -0.3 | 15 | V |
| Operating Temperature | T_OP | | -20 | 70 | °C |
| Storage Temperature. | T_{ST} | _ | -30 | 80 | Ô |
| Storage Humidity | H_D | Ta<40 °C | 20 | 90 | %RH |



1.4 DC Electrical Characteristics

Ta = 25°℃

| Item | Symbol | Condition | Min. | Typ. | Max. | Unit |
|----------------------|-----------------|--|--------------------|------|--------------------|------|
| Logic Supply Voltage | V_{dd} | _ | 2.6 | 2.8 | 3.0 | V |
| "H" Input Voltage | V _{IH} | _ | 0.7V _{DD} | | V _{DD} | V |
| "L" Input Voltage | V _{IL} | _ | Vss | | 0.3V _{DD} | V |
| "H" Output Voltage | V _{OH} | IOUT=1mA, VDD=1.8V | 0.8V _{DD} | _ | V _{DD} | ٧ |
| "L" Output Voltage | V_{OL} | IOUT=-1mA, VDD=1.8V | Vss | _ | 0.2V _{DD} | ٧ |
| Cumply Current | | V _{DD} = 2.8 V;V _{OP} = 8.5 V; Pattern= Full display | - | 0.2 | _ | |
| Supply Current | I _{dd} | V _{DD} = 2.8 V;V _{OP} = 8.5 V; Pattern= Horizontal line*1 | - | 0.2 | 0.5 | mA |
| | V _{OP} | -20 ℃ | 8.7 | 8.8 | 8.9 | |
| LCM Driver Voltage | | 25℃ | 8.3 | 8.5 | 8.7 | V |
| | *2 | 70℃ | 7.7 | 7.8 | 7.9 | |

NOTE: *1 The Maximum current display;

*2 The VOP test point is V0~XV0.



1.5 Optical Characteristics

LCD Panel: 1/68 Duty, 1/9 Bias, V_{LCD} = 8.5 V, Ta = 25°C

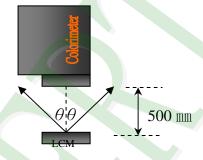
| Item | | Symbol | Conditions | Min. | Тур. | Max. | Unit | Reference |
|---------------------------|--------|--------------|--------------------|------|--------|--------|-------------------|-----------|
| Posnonce Time | Rise | tr | 25 ℃ | - | 120 ms | 180 ms | | Note2 |
| Response Time | Fall | tf | 25℃ | - | 200 ms | 300 ms | _ | Note2 |
| | Тор | ⊖ Y + | | - | 20 | - | | |
| Viewing angle | Bottom | ⊖ Y - | C <u>></u> 2.0, | ı | 30 | - | | Note 1 |
| range | Left | ⊖X- | Ø = 90° | - | 20 | - | <u>-</u> | Note i |
| | Right | ⊖ X + | | - | 25 | - | | |
| Contrast Ra | tio | С | θ = 0°, ∅ =90° | 2 | - | - | - | Note 3 |
| Average Bright (with B/L) | | IV | | 110 | 165 | 220 | cd/m ² | - |
| CIE Color Coor | dinate | X | IF= 20 mA | 0.23 | 0.28 | 0.33 | - | |
| (With B/L) |) | Y | | 0.25 | 0.30 | 0.35 | - | Note 4 |
| Uniformity | , | ∆В | | 70 | - | - | % | |



Note 4:

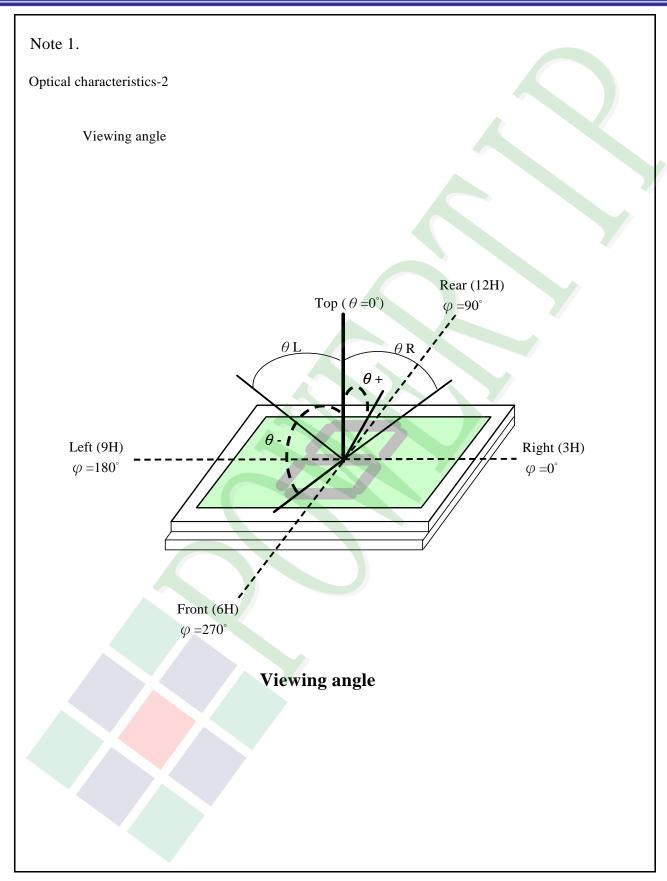
- 1 : △B=B(min) / B(max) * 100%
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%



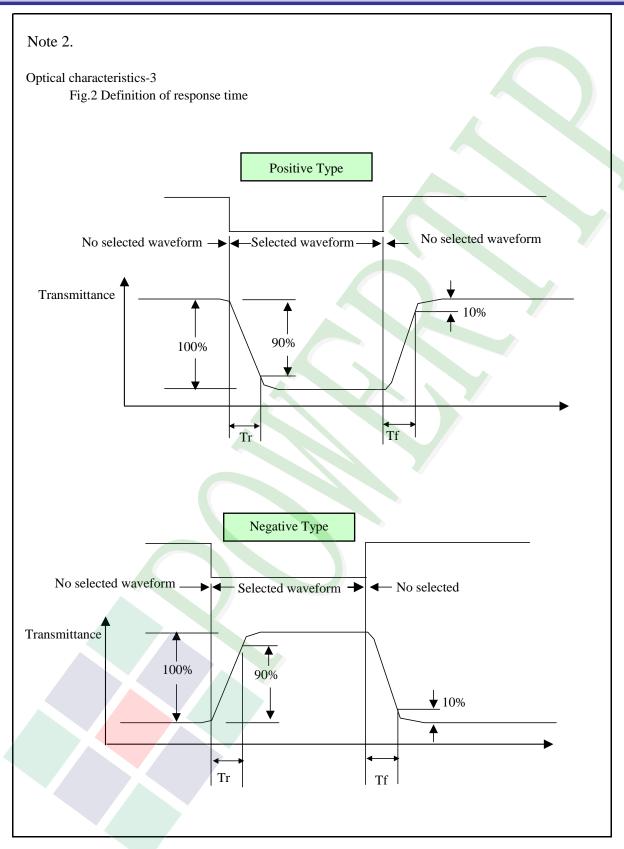


Colorimeter=BM-7 fast











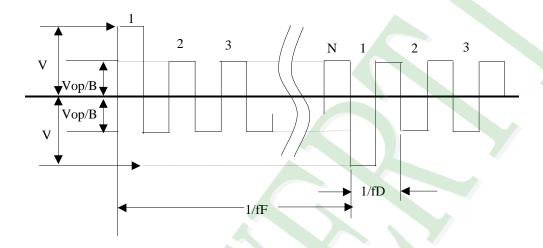
Electrical characteristics-2

※2 Drive waveform

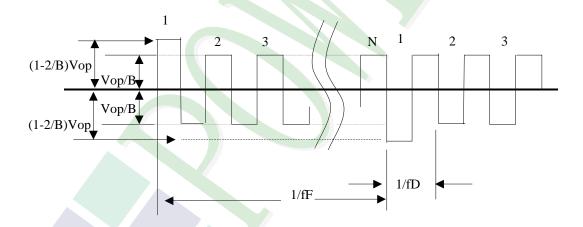
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

(1) Selected waveform



(2) Non- Selected wave form

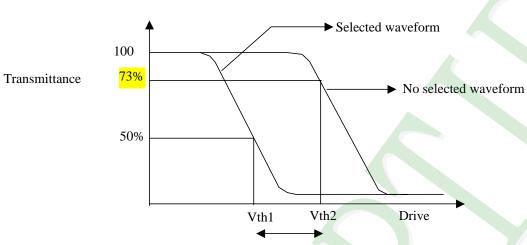


Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period







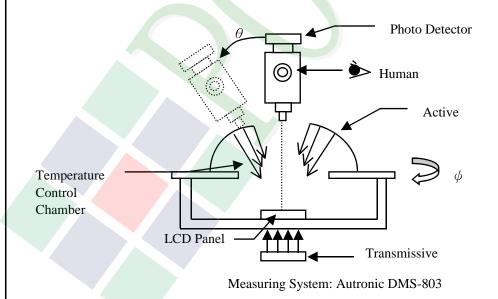
Active voltage range

| | Vth1 | Vth2 |
|----------------|---------------------|------------------------|
| View direction | 10° | 40° |
| Drive waveform | (Selected waveform) | (No selected waveform) |
| Transmittance | 50% | 73% |

※1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System





1.6 Backlight Characteristics

LCD Module with LED Backlight

Maximum Ratings

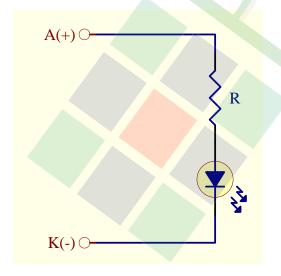
| Item | Symbol | Conditions | Min. | Max. | Unit |
|-----------------|----------------|------------|------|------|------|
| Forward Current | I _F | | - | 30 | mA |
| Reverse Current | I _R | To =25°C | | 0.05 | mA |
| Forward Voltage | V _F | Ta =25°C | - | 4 | V |
| Reverse Voltage | V _R | | - | 5 | V |

Electrical / Optical Characteristics

Ta =25°C

| Item | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|----------------------------------|--------|------------|-------|------|------|-------------------|
| Forward Voltage | VF | | 3.1 | 3.3 | 3.5 | V |
| Average Brightness (without LCD) | IV | IF= 20mA | 400 | 500 | 600 | cd/m ² |
| CIE Color Coordinate | X | | 0.25 | 0.28 | 0.31 | • |
| (without LCD) | Y | | 0.25 | 0.28 | 0.31 | - |
| Color | | | White | | | |

Internal Circuit Diagram:





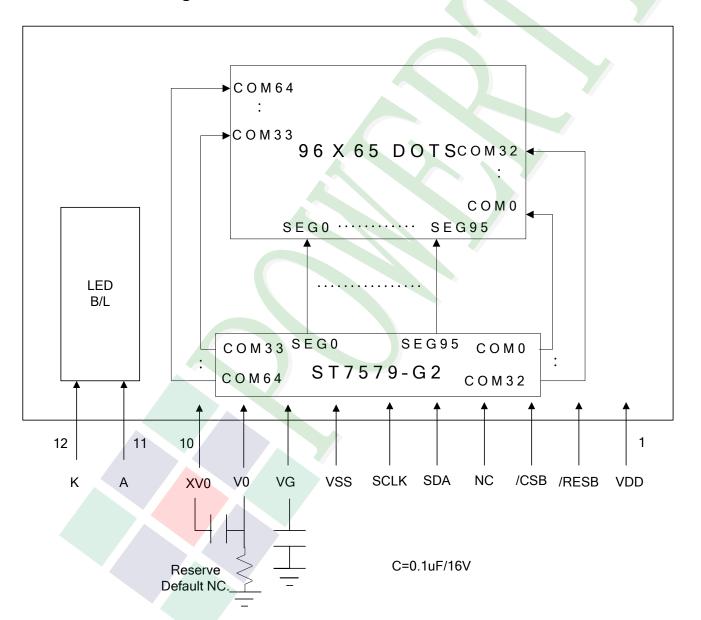
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





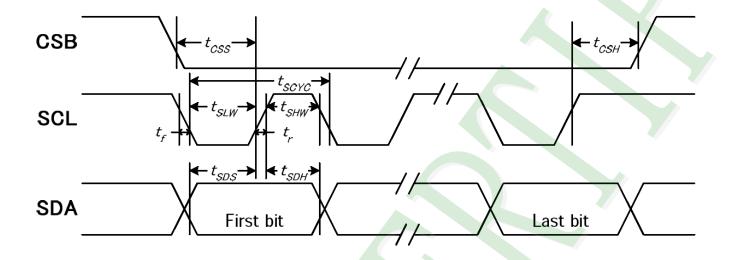
2.2 Interface Pin Description

| Pin No. | Symbol | Function |
|----------|--------|---|
| FIII NO. | Symbol | Tullction |
| 1 | VDD | Power supply. |
| 2 | /RESB | Reset input pin. When RESB is "L", internal initialization is executed. |
| 3 | /CSB | Chip select input pin. Interface access is enabled when CSB is "L". |
| 4 | NC | Not connection. |
| 5 | SDA | Serial data input, |
| 6 | SCLK | Serial clock input. |
| 7 | VSS | Ground. |
| 8 | VG | LCD driving voltage for segments. |
| 9 | V0 | LCD driving voltage for commons at negative frame. |
| 10 | XV0 | LCD driving voltage for commons at positive frame. |
| 11 | А | Backlight LED anode input pin. |
| 12 | K | Backlight LED cathode input pin. |



2.3 Timing Characteristics

SERIAL INTERFACE (3-Line Interface)



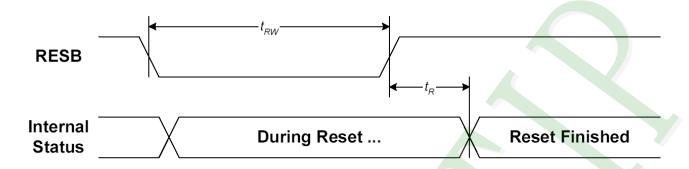
| Item | Signal | Symbol | Condition | Min. | Max. | Unit |
|----------------------|--------|--------|-----------|------|------|------|
| Serial clock period | | tSCYC | | 180 | _ | |
| SCLK "H" pulse width | SCLK | tSHW | | 90 | _ | |
| SCLK "L" pulse width | | tSLW | | 90 | _ | |
| Data setup time | 000 | | | 30 | _ | ns |
| Data hold time | SDA | tSDH | | 20 | _ | |
| CSB-SCLK time | CSB | tCSS | | 30 | _ | |
| CSB-SCLK time | CSB | tCSH | | 160 | _ | |

^{*1} The input signal rise and fall time (tr, tf) are specified at 15 ns or less.

^{*2} All timing is specified using 20% and 80% of VDD1 as the standard.



RESET TIMING

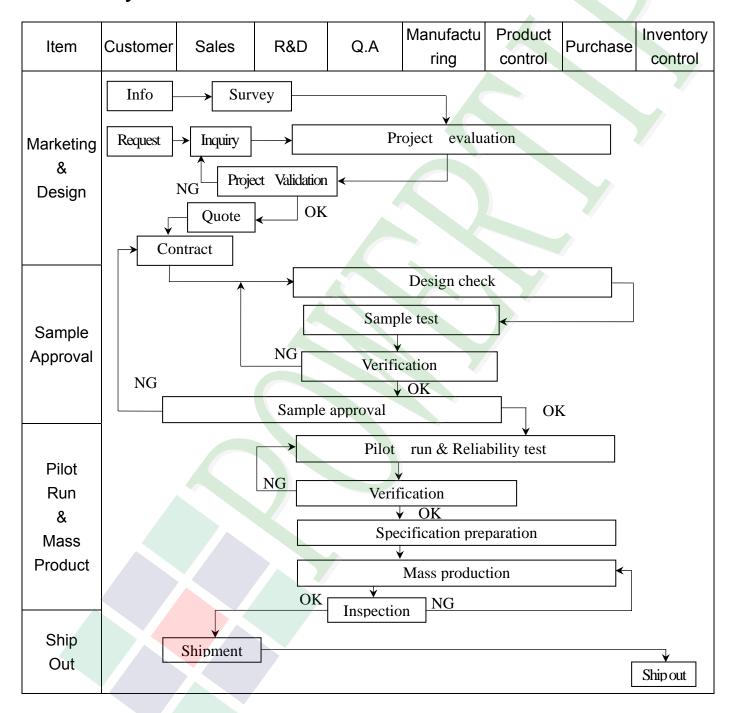


| ltem | Symbol | Condition | Min. | Max. | Unit |
|-----------------------|--------|-----------|------|------|------|
| Reset time | tR | | 1 | 2.0 | 116 |
| Reset "L" pulse width | tRW | | 2.0 | | us |

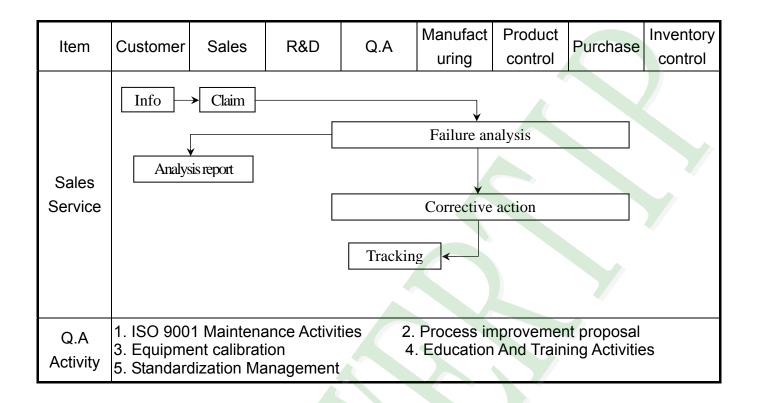


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN(Ver. 02).
- ♦Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level II .
- ◆Equipment : Gauge \ MIL-STD \ Powertip Tester \ Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- **♦**OUT Going Defect Level : Sampling .
- **◆**Manner of appearance test :
 - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). Standard of inspection: (Unit: mm)
 - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (4). Definition of area . (Fig. 2)

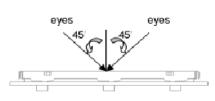


Fig.1

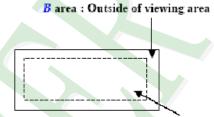


Fig. 2 A area: viewing area

♦ Specification:

| NO | Item | Criterion | level |
|----|--------------------|---|-------|
| | | 1. 1 The part number is inconsistent with work order of Production. | Major |
| 01 | Product condition | 1, 2 Mixed production types. | Major |
| | | 1.3 Assembled in inverse direction. | Major |
| 02 | Quantity | 2. 1 The quantity is inconsistent with work order of production. | Major |
| 03 | Outline dimension | 3. 1 Product dimension and structure must conform to Structure diagram. | Major |
| | | 4. 1 Missing line character and icon. | Major |
| 04 | Electrical Testing | 4. 2 No function or no display. | Major |
| | | 4. 3 Output data is error. | Major |
| | | 4. 4 LCD viewing angle defect. | Major |
| | | 4.5 Current consumption exceeds product specifications. | Major |



| <u> </u> | | | | | | (ver. UZ) | |
|----------|--|--|---|--|--|---|----------|
| NO 05 | Item Black or white dot \ scratch \ contamination Round type \(\frac{x}{y} \) \(\frac{y}{x} \) \(\frac{y}{y} \) Line type \(\frac{x}{y} \) \(\frac{y}{y} \) \(\frac{x}{y} \) | 5. 1 Round type 5. 1. 1 display • White and 4 white of • Densely sp 5. 1. 2 Non-dif Dimension 0. 10 < 0. 20 < | e: y only: black spots r black spots vaced: NO m splay: (diameter: Φ ≤ 0. 10 Φ ≤ 0. 20 Φ ≤ 0. 30 Total quantity pe: Dimension Width v 0. 03 < v 0. 05 < v | (W) V ≤ 0.03 V ≤ 0.05 V ≤ 0.075 | Accept no d Accept no d Accept no d Accept no dense | ense eptance (Q'ty) B area Don't count Don't count | n. Minor |
| | | | y | v > 0. 075 | A | s round type | |
| 06 | Polarizer Bubble | 0. 20 < Φ 0. 50 < Φ | ≤ 0.20 ≤ 0.50 ≤ 1.00 > 1.00 | A are Accept n 3 2 0 | o dense | Q'ty) Barea Don't count Don't count Don't count Don't count Don't count | Minor |



| NO | Item | Criterion | Level |
|----|--------------|---|-------|
| | | Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length | |
| | | 7. 1 General glass chip: 7. 1. 1 Chip on panel surface and crack between panels: | |
| | The crack of | SP—SP | |
| 07 | glass | Y [NG] [OK] | Minor |
| | | Seal width Z | |
| | | ≤ a Crack can't enter viewing area ≤1/2 t | |
| | | $\leq a \qquad \begin{array}{c} \text{Crack can't exceed the} \\ \text{half of SP width.} \end{array} 1/2 \;\; t \; < \; Z \leq 2 \;\; t$ | |
| | | | |



| NO | Item | Criterion | | |
|----|--------------|---|-------|--|
| | | Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length t: LCD side length | | |
| | | 7.1.2 Corner crack: | | |
| | | X Y Z | | |
| | | ≤1/5 a Crack can't enter viewing area Z ≤ 1/2 t | | |
| | The crack of | $\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t $<$ Z ≤ 2 t | | |
| 07 | glass | 7.2 Protrusion over terminal: | Minor | |
| | | 7. 2. 1 Chip on electrode pad: | | |
| | | X X X X X X X X X X | | |
| | | W X | | |
| | | X Y Z | | |
| | | Front \leq a \leq 1/2 W \leq t | | |
| | | Back Neglect | | |
| | | | | |



| NO | Item | Criterion | Level |
|----|--------------------|---|-------|
| | | Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length | |
| | | 7.2.2 Non-conductive portion: W X X | |
| | | Z Y Z | |
| 07 | The crack of glass | ≤1/3 a ≤W ≤t ⊙ If the chipped area touches the ITO terminal, over 2/3 of | Minor |
| | | the ITO must remain and be inspected according to electrode terminal specifications. | |
| | | 7. 2. 3 Glass remain : Y X Pitch | |
| | | $\begin{array}{c cccc} X & Y & Z \\ & \leq a & \leq 1/3 \text{ W} & \leq t \end{array}$ | |



| NO | Item | Criterion | Level |
|----|--|---|-------|
| | | 8. 1 Backlight can't work normally. | Major |
| 08 | Backlight elements | 8. 2 Backlight doesn't light or color is wrong. | Major |
| | | 8. 3 Illumination source flickers when lit. | Major |
| | | 9. 1 Pin type must match type in specification sheet. | Major |
| | | 9. 2 No short circuits in components on PCB or FPC. | Major |
| 09 | General appearance | 9. 3 Product packaging must the same as specified on packaging specification sheet. | Minor |
| | 9. 4 The folding and peeled off in polarizer are not acceptable. | 9. 4 The folding and peeled off in polarizer are not acceptable. | Minor |
| | | 9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤ 1.5 mm. | Minor |



4. RELIABILITY TEST

4.1 Reliability Test Condition

| NO. | TEST ITEM | TEST CONDITION | | |
|-----|---|---|--|--|
| 1 | High Temperature Storage Test | Keep in $+80 \pm 2^{\circ}\text{C}$ 96 hrs Surrounding temperature, then storage at normal condition 4hrs. | | |
| 2 | Low Temperature Storage Test | Keep in $-30~\pm2^{\circ}$ C 96 hrs Surrounding temperature, then storage at normal condition 4hrs. | | |
| 3 | High Temperature / High Humidity Storage Test | Keep in +60°C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer) | | |
| 4 | ESD Test | Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: $15^{\circ}\text{C} \sim 35^{\circ}\text{C}$ 2. Humidity relative: $30\% \sim 60\%$ 3. Energy Storage Capacitance(Cs+Cd): $150\text{pF}\pm10\%$ 4. Discharge Resistance(Rd): $330\Omega\pm10\%$ 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: $\pm5\%$) | | |
| 5 | Temperature Cycling Storage Test | $-20^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +70^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ $(30\text{mins}) (5\text{mins}) (5\text{mins})$ 10 Cycle Surrounding temperature, then storage at normal condition 4hrs. | | |
| 6 | Vibration Test (Packaged) | Sine wave 10~55 Hz frequency (1 min) The amplitude of vibration :1. 5 mm Each direction (X \cdot Y \cdot Z) duration for 2 Hrs | | |
| 7 | Drop Test (Packaged) | Packing Weight (Kg) 0 ~ 45. 4 122 45. 4 ~ 90. 8 76 90. 8 ~ 454 61 Over 454 46 Drop direction: **1 corner / 3 edges / 6 sides each 1 times | | |



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

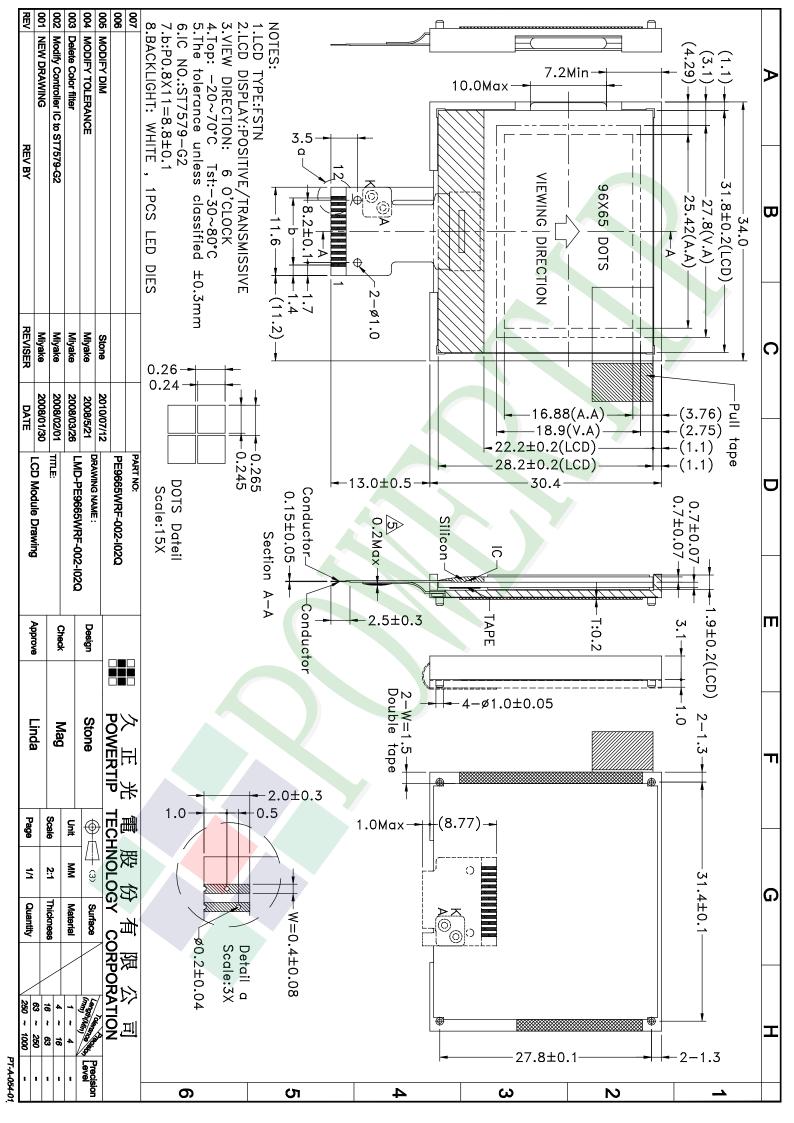
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.003 LCM包裝規格書 LCM Packaging Specifications Oliver Max Miyake Documents NO. PKG-PE9665WRF-002-I02Q (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. Model Dimensions (mm) 1Pcs Weight Quantity Total Weight PE9665WRF-002-I02Q 1 成品 (LCM) 34.0 X 30.4 1620 0.0048 7.776 2 多層薄膜(1)POF 19"X350X0.015 OTFILM0BA03ABA 3 60 TRAY 盤 (2)Tray TY00000000015 352 X 260 X 10.8 6.0 0.1 内盒(3)Product Box BX36627063ABBA 4 393 X 274 X 68 0.2692 6 1.6152 5 保利龍板(4)Polylon board OTPLB00PL08ABA 550 X 393 X 20 0.0284 0.0568 6 外紙箱(5)Carton 570 X 410 X 265 BX57041027CCBA 1.4208 1.4208 7 8 9 2. 一整箱總重量 (Total LCD Weight in carton): 16.87 Kg±10% 3. 單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box: no per tray x no of tray 30 270 (2)Total LCM quantity in carton: quantity per box x no of boxes 270 1620 6 Use empty tray 空盤 (4)保利龍板 (1)多層薄膜 Polylon board **POF** Put products into the tray (2)TRAY 盤 Trav (5)外紙箱 Carton Tray stacking (3)內盒 Product Box 特 記 事 項 (REMARK) 3.可適用於單品包裝 1. Label Specifications: 斜角 Detail B It's also suitable to Panel MODEL: 4.Tray料號: LOT NO: Tray Number: TY00000000015 **OUANTITY:** Tray 2 CHECK: 圓角 Tray 1 2.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.